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Team Nexperia



PBSS304PD 80 V, 3 A PNP low V_{CEsat} (BISS) transistor Rev. 02 – 24 March 2009

Product data sheet

1. Product profile

1.1 General description

PNP low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a SOT457 (SC-74) small Surface-Mounted Device (SMD) plastic package.

NPN complement: PBSS304ND.

1.2 Features

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

1.3 Applications

- High-voltage DC-to-DC conversion
- High-voltage MOSFET gate driving
- High-voltage motor control
- High-voltage power switches (e.g. motors, fans)
- Thin Film Transistor (TFT) backlight inverter
- Automotive applications

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	-80	V
I _C	collector current		<u>[1]</u> _	-	-3	А
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms	-	-	-5	A
R _{CEsat}	collector-emitter saturation resistance	$I_{\rm C} = -2 \text{ A};$ $I_{\rm B} = -200 \text{ mA}$	[2]	75	100	mΩ

[1] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

[2] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.



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2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	collector		
2	collector		1, 2, 5, 6
3	base		3
4	emitter		4
5	collector		4 sym030
6	collector		

3. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
PBSS304PD	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457		

4. Marking

Table 4.	Marking codes	
Type num	iber	Marking code
PBSS304	PD	AJ

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5. Limiting values

Table 5. In accordar	Limiting values ace with the Absolute Maximu	ım Rating System (IE	EC 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	-80	V
V _{CEO}	collector-emitter voltage	open base	-	-80	V
V _{EBO}	emitter-base voltage	open collector	-	-5	V
I _C	collector current		<u>[1]</u> -	-1	А
			[2] _	-3	А
I _{CM}	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	-5	A
I _B	base current		-	-800	mA
I _{BM}	peak base current	single pulse; $t_p \leq 1 \text{ ms}$	-	-2	A
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	360	mW
			<u>[3]</u> _	600	mW
			<u>[4]</u> _	750	mW
			[2] _	1.1	W
			[1][5] _	2.5	W
Тj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

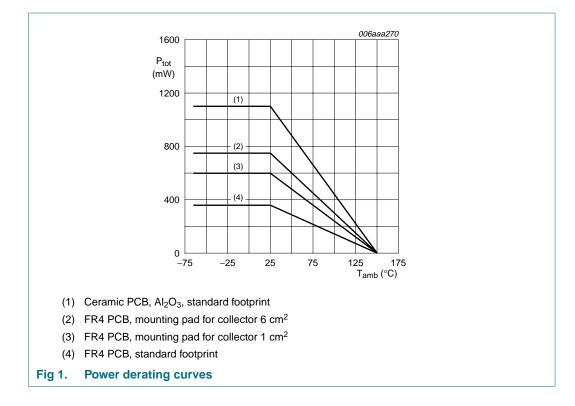
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

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6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	n in free air	<u>[1]</u> -	-	350	K/W
	junction to ambient		[2]	-	208	K/W
			[3] _	-	167	K/W
			[4] _	-	113	K/W
			[1][5] _	-	50	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	45	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

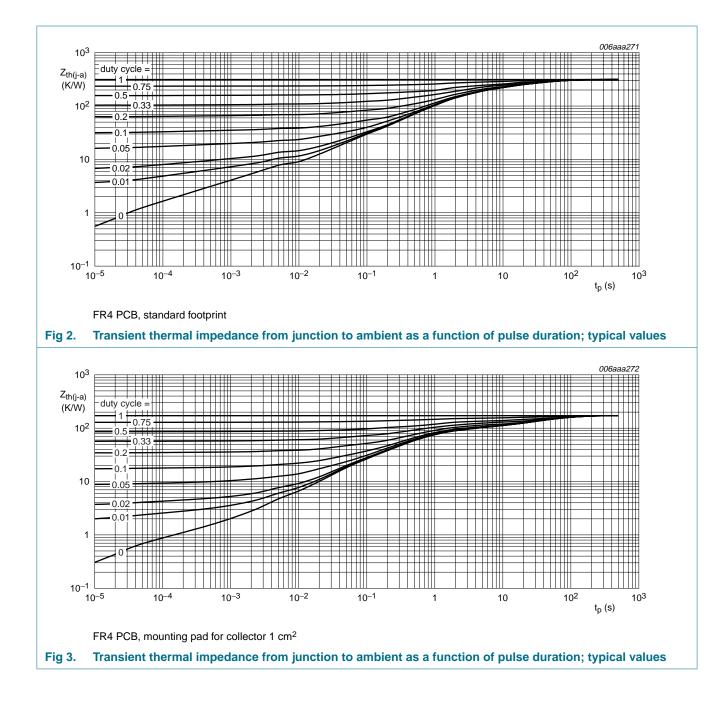
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

[4] Device mounted on a ceramic PCB, AI_2O_3 , standard footprint.

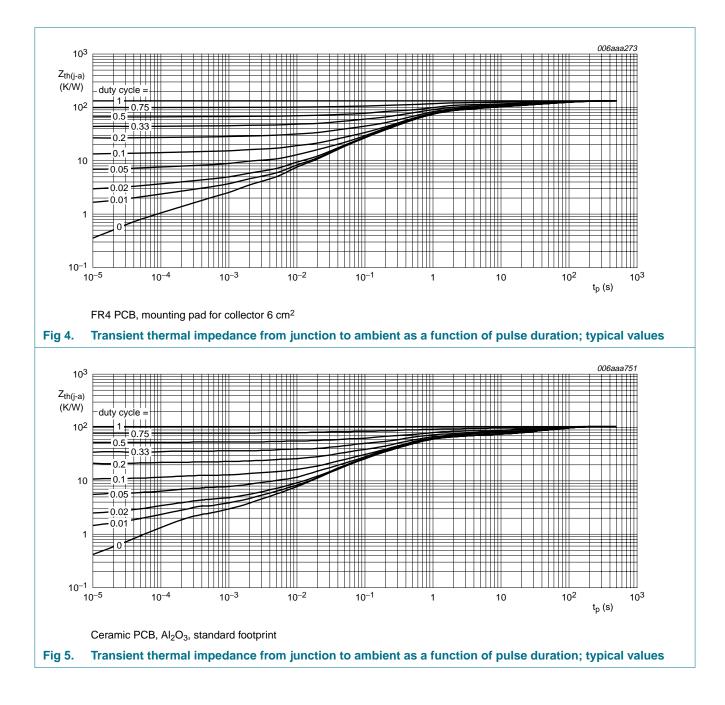
PBSS304PD

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PBSS304PD

80 V, 3 A PNP low V_{CEsat} (BISS) transistor



PBSS304PD 2

80 V, 3 A PNP low V_{CEsat} (BISS) transistor

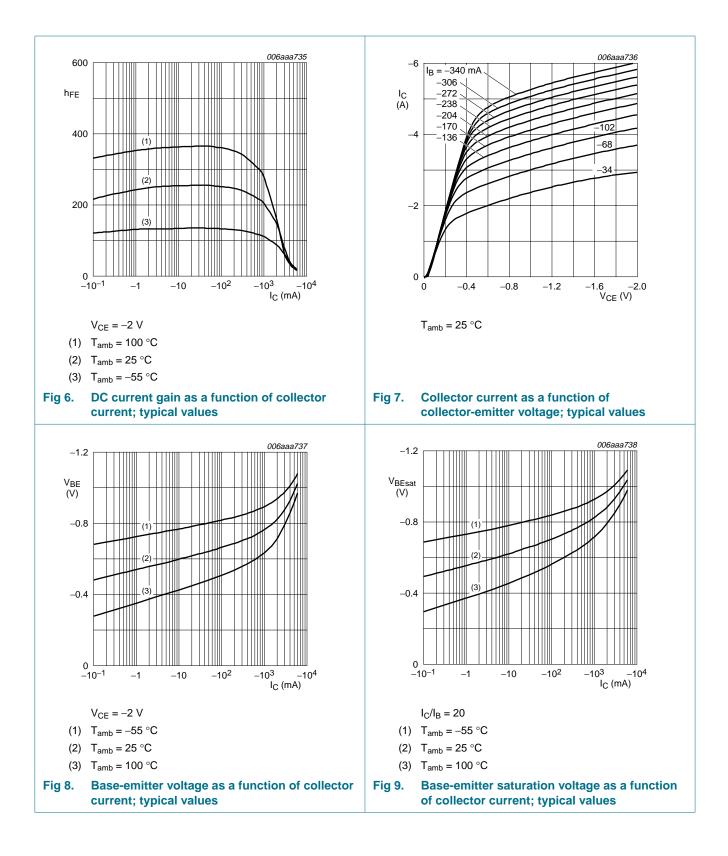
7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}		$V_{CB} = -80 \text{ V}; I_E = 0 \text{ A}$		-	-	-100	nA
	current	$\label{eq:VCB} \begin{array}{l} V_{CB} = -80 \text{ V}; \text{ I}_{E} = 0 \text{ A}; \\ T_{j} = 150 \ ^{\circ}\text{C} \end{array}$		-	-	-50	μΑ
I _{CES}	collector-emitter cut-off current	$V_{CE} = -64 \text{ V}; V_{BE} = 0 \text{ V}$		-	-	-100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$		-	-	-100	nA
h _{FE}	DC current gain	V_{CE} = -2 V; I_C = -500 mA		155	225	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	<u>[1]</u>	140	200	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -2 \text{ A}$	[1]	105	145	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -3 \text{ A}$	[1]	60	85	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -4 \text{ A}$	[1]	30	45	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -5 \text{ A}$	[1]	20	25	-	
V _{CEsat}	collector-emitter	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}$		-	-55	-75	mV
	saturation voltage	$I_{\rm C} = -1$ A; $I_{\rm B} = -50$ mA		-	-110	-145	mV
		$I_{\rm C} = -2$ A; $I_{\rm B} = -200$ mA	<u>[1]</u>	-	-150	-200	mV
		$I_{C} = -3 \text{ A}; I_{B} = -150 \text{ mA}$	<u>[1]</u>	-	-315	-415	mV
		$I_{C} = -3 \text{ A}; I_{B} = -300 \text{ mA}$	<u>[1]</u>	-	-215	-290	mV
		$I_{C} = -4 \text{ A}; I_{B} = -400 \text{ mA}$	<u>[1]</u>	-	-295	-390	mV
		$I_{C} = -5 \text{ A}; I_{B} = -500 \text{ mA}$	<u>[1]</u>	-	-410	-540	mV
R _{CEsat}	collector-emitter saturation resistance	$I_{C} = -2 \text{ A}; I_{B} = -200 \text{ mA}$	<u>[1]</u>	-	75	100	mΩ
V _{BEsat}	base-emitter	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}$		-	-0.78	-0.87	V
	saturation voltage	$I_{C} = -1 \text{ A}; I_{B} = -50 \text{ mA}$		-	-0.80	-0.89	V
		$I_{C} = -1 \text{ A}; I_{B} = -100 \text{ mA}$	[1]	-	-0.83	-0.91	V
		$I_{C} = -3 \text{ A}; I_{B} = -150 \text{ mA}$	[1]	-	-0.92	-0.99	V
		$I_{C} = -3 \text{ A}; I_{B} = -300 \text{ mA}$	[1]	-	-0.94	-1.01	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -2 \text{ A}$		-	-0.80	-1.00	V
t _d	delay time	$V_{CC} = -9.2 \text{ V}; I_C = -2 \text{ A};$		-	13	-	ns
t _r	rise time	$I_{Bon} = -0.1 \text{ A}; I_{Boff} = 0.1 \text{ A}$		-	77	-	ns
t _{on}	turn-on time			-	90	-	ns
t _s	storage time			-	210	-	ns
t _f	fall time			-	102	-	ns
t _{off}	turn-off time			-	312	-	ns
f _T	transition frequency	$\label{eq:Vce} \begin{array}{l} V_{CE} = -10 \text{ V}; \text{ I}_{C} = -100 \text{ mA}; \\ f = 100 \text{ MHz} \end{array}$		-	110	-	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz		-	45	-	pF

 $\label{eq:point} \begin{tabular}{ll} \mbox{Pulse test: } t_p \leq 300 \ \mu s; \ \delta \leq 0.02. \end{tabular}$

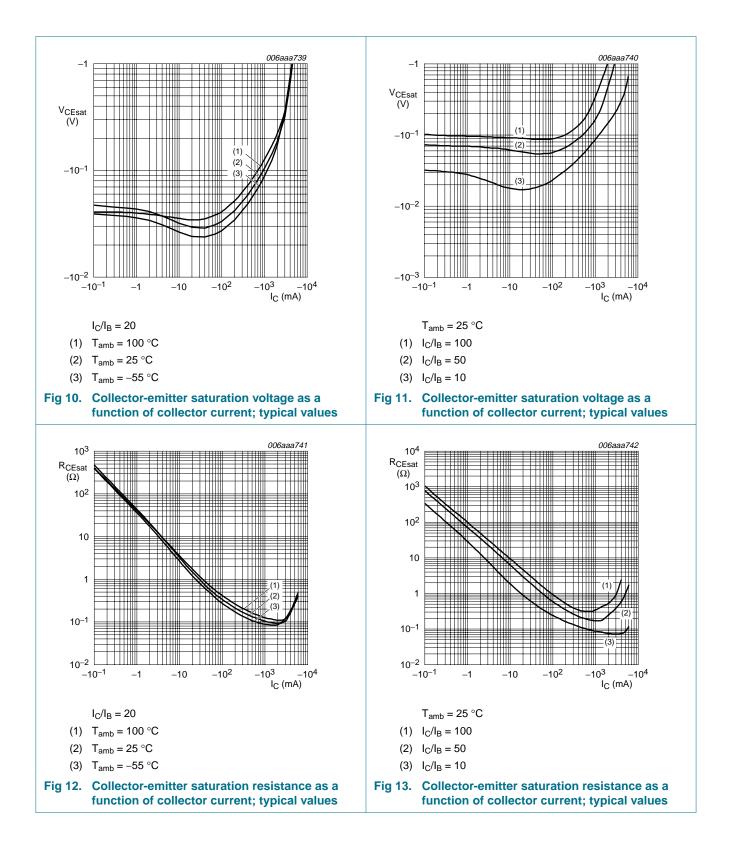
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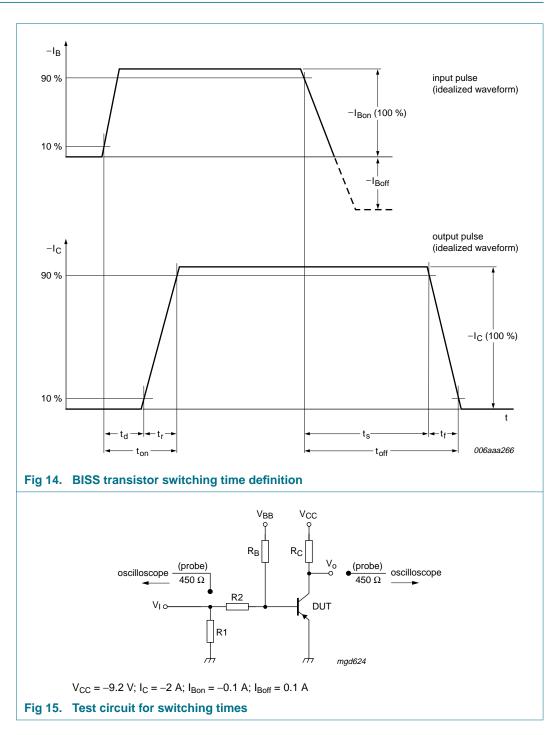
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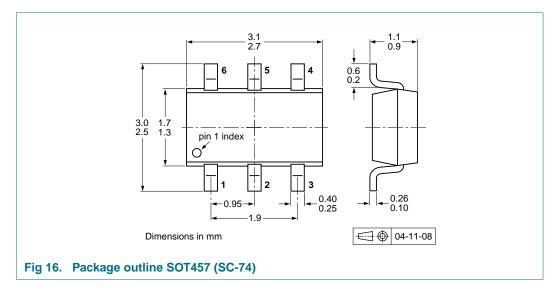
80 V, 3 A PNP low V_{CEsat} (BISS) transistor

8. Test information



80 V, 3 A PNP low V_{CEsat} (BISS) transistor

9. Package outline



10. Packing information

Table 8.Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description		Packing quantity	
				3000	10000
PBSS304PD	SOT457	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-135
		4 mm pitch, 8 mm tape and reel; T2	<u>[3]</u>	-125	-165

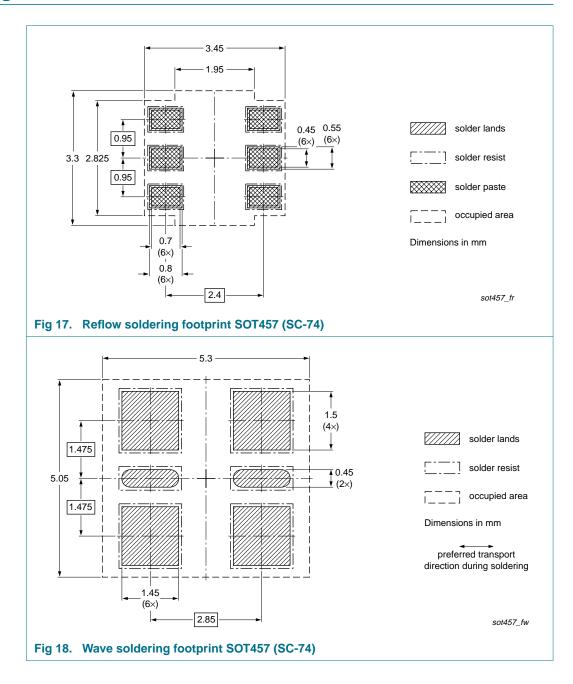
[1] For further information and the availability of packing methods, see <u>Section 14</u>.

[2] T1: normal taping

[3] T2: reverse taping

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11. Soldering



80 V, 3 A PNP low V_{CEsat} (BISS) transistor

12. Revision history

Table 9. Revision histo	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PBSS304PD_2	20090324	Product data sheet	-	PBSS304PD_1
Modifications:	guidelines of	f this data sheet has been rede NXP Semiconductors. ave been adapted to the new o		
	• Figure 5 and	13: amended		
	 Section 13 "L 	egal information": updated		
PBSS304PD_1	20060530	Product data sheet	-	-

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13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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